

PATENT ASSIGNMENT

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| SUBMISSION TYPE: | NEW ASSIGNMENT | APPLICATION NUMBER 11/308148 |
| NATURE OF CONVEYANCE: | ASSIGNMENT OF ASSIGNOR'S INTEREST | |

CONVEYING PARTY DATA

| Name | Execution Date |
|-------------------|----------------|
| Ching-Hsing Huang | 2006-02-14 |
| Wun-Chang Shih | 2006-02-14 |
| Chien-Long Hong | 2006-02-14 |
| Huan-Chao Lin | 2006-02-14 |
| Wei-Ben Wang | 2006-02-14 |
| Fong-Tan Yu | 2006-02-14 |
| Hsien-Sheng Pei | 2006-02-14 |

RECEIVING PARTY DATA

| Name | Street Address | Internal Address | City | State/Country | Postal Code |
|-----------------------------|-------------------------------------|------------------|--------------|---------------|-------------|
| Foxconn Technology Co.,Ltd. | 3-2, Chung Shan Road, Tu-Cheng City | | Taipei Hsien | TAIWAN | |

CORRESPONDENCE DATA

FAX NUMBER: 8064986673

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

When the customer number has been provided, the Office of Public Records will obtain the correspondence data from the official record on file at the USPTO.

CUSTOMER NUMBER: 027765

| | |
|-------------------------|-------------|
| NAME OF PERSON SIGNING: | WINSTON HSU |
| DATE SIGNED: | 2006-03-07 |

Total Attachments: 9

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CH \$40.00 503105 11308148

PATENT

Docket No

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGNOR(S) (Inventors):

Name: Ching-Hsing Huang Nationality: R.O.C.

Address: Mailbox 117, No. 2, 2nd Donghuan Road, 10th Yousong Industrial Park, Longhua Town, Baoan District, Shenzhen, Guangdong, 518109, P.R.C.

Name: Wun-Chang Shih Nationality: R.O.C.

Address: Mailbox 117, No. 2, 2nd Donghuan Road, 10th Yousong Industrial Park, Longhua Town, Baoan District, Shenzhen, Guangdong, 518109, P.R.C.

Name: Chien-Long Hong Nationality: R.O.C.

Address: Mailbox 117, No. 2, 2nd Donghuan Road, 10th Yousong Industrial Park, Longhua Town, Baoan District, Shenzhen, Guangdong, 518109, P.R.C.

Name: Huan-Chao Lin Nationality: R.O.C.

Address: Mailbox 117, No. 2, 2nd Donghuan Road, 10th Yousong Industrial Park, Longhua Town, Baoan District, Shenzhen, Guangdong, 518109, P.R.C.

Name: Wei-Ben Wang Nationality: R.O.C.

Address: Mailbox 117, No. 2, 2nd Donghuan Road, 10th Yousong Industrial Park, Longhua Town, Baoan District, Shenzhen, Guangdong, 518109, P.R.C.

Name: Fong-Tan Yu Nationality: R.O.C.

Address: Mailbox 117, No. 2, 2nd Donghuan Road, 10th Yousong Industrial Park, Longhua Town, Baoan District, Shenzhen, Guangdong, 518109, P.R.C.

Name: Hsien-Sheng Pei Nationality: R.O.C.

Address: Mailbox 117, No. 2, 2nd Donghuan Road, 10th Yousong Industrial Park, Longhua Town, Baoan District, Shenzhen, Guangdong, 518109, P.R.C.

Hereby sells, assigns and transfers to

ASSIGNEE(S):

Name: Foxconn Technology Co.,Ltd..

Address: 3-2, Chung Shan Road, Tu-cheng City, Taipei Hsien, Taiwan, R.O.C.

and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

"Liquid Pump "

Which is found in :

- (a) ___ + ___ U.S. patent application executed on even date
- (b) _____ U.S. patent application executed on _____
- (c) _____ U.S. application serial no. _____
- (d) _____ patent no. _____ issued _____

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this Feb. 14, 2006 (Date of signing). (請發明人務必簽署上列日期。)

(Type name of inventor)

Ching-Hsing Huang

Signature of INVENTOR

Ching-Hsing Huang

IN WITNESS WHEREOF, We have hereunto set hand and seal this Feb.14,2006(Date of signing). (請發明人務必簽署上列日期。)

(Type name of inventor)

Wun-Chang Shih

Signature of INVENTOR

Wun-Chang Shih

IN WITNESS WHEREOF, We have hereunto set hand and seal this Feb. 14, 2006 (Date of signing). (請發明人務必簽署上列日期。)

(Type name of inventor)

Signature of INVENTOR

Chien-Long Hong

Chien-Long Hong

IN WITNESS WHEREOF, We have hereunto set hand and seal this Feb. 14, 2006 (Date of signing). (請發明人務必簽署上列日期。)

(Type name of inventor)

Huan-Chao Lin

Signature of INVENTOR

Huan-Chao Lin.

IN WITNESS WHEREOF, We have hereunto set hand and seal this Feb.14,2006(Date of signing). (請發明人務必簽署上列日期。)

(Type name of inventor)

Signature of INVENTOR

Wei-Ben Wang

Wei-Ben Wang

IN WITNESS WHEREOF, We have hereunto set hand and seal this Feb. 14, 2006 (Date of signing). (請發明人務必簽署上列日期。)

(Type name of inventor)

Signature of INVENTOR

Fong-Tan Yu

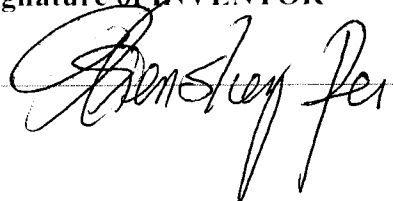
Fong-Tan Yu

IN WITNESS WHEREOF, We have hereunto set hand and seal this Feb. 14, 2006 (Date of signing). (請發明人務必簽署上列日期。)

(Type name of inventor)

Hsien-Sheng Pei

Signature of INVENTOR

A handwritten signature in black ink, appearing to read 'Hsien-Sheng Pei', written over a horizontal line.